

ISL3170E, ISL3171E, ISL3172E, ISL3173E, ISL3174E, ISL3175E, ISL3176E, ISL3177E, ISL3178E

±15kV ESD Protected, 3.3V, Full Fail-Safe, Low Power, High Speed or Slew Rate Limited, RS-485/RS-422 Transceivers

The Renesas ISL317xE ([ISL3170E](#), [ISL3171E](#), [ISL3172E](#), [ISL3173E](#), [ISL3174E](#), [ISL3175E](#), [ISL3176E](#), [ISL3177E](#), [ISL3178E](#)) are ±15kV IEC61000 ESD protected, 3.3V powered single transceivers that meet both the RS-485 and RS-422 standards for balanced communication. These devices have very low bus currents (+125µA/-100µA), so they present a true "1/8 unit load" to the RS-485 bus. This allows up to 256 transceivers on the network without violating the RS-485 specification's 32 unit load maximum, and without using repeaters. For example, in a remote utility meter reading system, individual meter readings are routed to a concentrator using an RS-485 network, so the high allowed node count minimizes the number of repeaters required.

Receiver (Rx) inputs feature a "Full Fail-Safe" design, which ensures a logic high Rx output if Rx inputs are floating, shorted, or terminated but undriven.

Hot Plug circuitry ensures that the Tx and Rx outputs remain in a high impedance state while the power supply stabilizes.

The ISL3170E through ISL3175E utilize slew rate limited drivers which reduce EMI, and minimize reflections from improperly terminated transmission lines, or unterminated stubs in multidrop and multipoint applications. Slew rate limited versions also include receiver input filtering to enhance noise immunity in the presence of slow input signals.

The ISL3170E, ISL3171E, ISL3173E, ISL3174E, ISL3176E, and ISL3177E are configured for full duplex (separate Rx input and Tx output pins) applications. The half duplex versions multiplex the Rx inputs and Tx outputs to allow transceivers with output disable functions in 8 Ld packages.

## Features

- IEC61000-4-2 ESD protection on RS-485 I/O pins . . ±15kV  
- HBM Class 3 ESD level on all other pins . . . . . >7kV
- Full fail-safe (open, short, terminated/floating) receivers
- Hot plug - Tx and Rx outputs remain three-state during power-up (only versions with output enable pins)
- True 1/8 unit load allows up to 256 devices on the bus
- Single 3.3V supply
- High data rates . . . . . up to 20Mbps
- Low quiescent supply current . . . . . 800µA (Max)  
- Ultra low shutdown supply current . . . . . 10nA
- -7V to +12V common-mode input/output voltage range
- Half and full duplex pinouts
- Three state Rx and Tx outputs available
- Current limiting and thermal shutdown for driver overload protection
- Tiny MSOP packages consume 50% less board space
- Pb-free (RoHS compliant)

## Applications

- Automated utility meter reading systems
- High node count systems
- Field bus networks
- Security camera networks
- Building environmental control/lighting systems
- Industrial/process control networks

TABLE 1. SUMMARY OF FEATURES

| PART NUMBER | HALF/FULL DUPLEX | DATA RATE (Mbps) | SLEW-RATE LIMITED? | HOT PLUG? | # DEVICES ON BUS | RX/TX ENABLE? | QUIESCENT I <sub>CC</sub> (µA) | LOW POWER SHUTDOWN? | PIN COUNT |
|-------------|------------------|------------------|--------------------|-----------|------------------|---------------|--------------------------------|---------------------|-----------|
| ISL3170E    | Full             | 0.25             | Yes                | Yes       | 256              | Yes           | 510                            | Yes                 | 10, 14    |
| ISL3171E    | Full             | 0.25             | Yes                | No        | 256              | No            | 510                            | No                  | 8         |
| ISL3172E    | Half             | 0.25             | Yes                | Yes       | 256              | Yes           | 510                            | Yes                 | 8         |
| ISL3173E    | Full             | 0.5              | Yes                | Yes       | 256              | Yes           | 510                            | Yes                 | 10, 14    |
| ISL3174E    | Full             | 0.5              | Yes                | No        | 256              | No            | 510                            | No                  | 8         |
| ISL3175E    | Half             | 0.5              | Yes                | Yes       | 256              | Yes           | 510                            | Yes                 | 8         |
| ISL3176E    | Full             | 20               | No                 | Yes       | 256              | Yes           | 510                            | Yes                 | 10, 14    |
| ISL3177E    | Full             | 20               | No                 | No        | 256              | No            | 510                            | No                  | 8         |
| ISL3178E    | Half             | 20               | No                 | Yes       | 256              | Yes           | 510                            | Yes                 | 8         |

## Ordering Information

| PART NUMBER<br>(Notes 2, 3)                                               | PART MARKING | PACKAGE DESCRIPTION<br>(RoHS Compliant) | PKG. DWG. # | CARRIER TYPE<br>(Note 1) | TEMP. RANGE  |
|---------------------------------------------------------------------------|--------------|-----------------------------------------|-------------|--------------------------|--------------|
| ISL3170EIBZ                                                               | 3170EIBZ     | 14 Ld SOIC                              | M14.15      | Tube                     | -40 to +85°C |
| ISL3170EIBZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3170EIBZ-T7A                                                           |              |                                         |             | Reel, 250                |              |
| ISL3170EIUZ                                                               | 3170Z        | 10 Ld MSOP                              | M10.118     | Tube                     |              |
| ISL3170EIUZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3171EIBZ                                                               | 3171<br>EIBZ | 8 Ld SOIC                               | M8.15       | Tube                     |              |
| ISL3171EIBZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3171EIBZ-T7A                                                           |              |                                         |             | Reel, 250                |              |
| ISL3171EIUZ                                                               | 3171Z        | 8 Ld MSOP                               | M8.118      | Tube                     |              |
| ISL3171EIUZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3172EIBZ                                                               | 3172<br>EIBZ | 8 Ld SOIC                               | M8.15       | Tube                     |              |
| ISL3172EIBZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3172EIBZ-T7A                                                           |              |                                         |             | Reel, 250                |              |
| ISL3172EIUZ                                                               | 3172Z        | 8 Ld MSOP                               | M8.118      | Tube                     |              |
| ISL3172EIUZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3173EIBZ                                                               | 3173EIBZ     | 14 Ld SOIC                              | M14.15      | Tube                     |              |
| ISL3173EIBZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3173EIUZ                                                               | 3173Z        | 10 Ld MSOP                              | M10.118     | Tube                     |              |
| ISL3173EIUZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3174EIBZ No longer available, recommended replacement: ISL3177EIBZ     | 3174<br>EIBZ | 8 Ld SOIC                               | M8.15       | Tube                     |              |
| ISL3174EIBZ-T No longer available, recommended replacement: ISL3177EIBZ-T |              |                                         |             | Reel, 2.5k               |              |
| ISL3174EIUZ                                                               | 3174Z        | 8 Ld MSOP                               | M8.118      | Tube                     |              |
| ISL3174EIUZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3175EIBZ                                                               | 3175<br>EIBZ | 8 Ld SOIC                               | M8.15       | Tube                     |              |
| ISL3175EIBZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3175EIUZ                                                               | 3175Z        | 8 Ld MSOP                               | M8.118      | Tube                     |              |
| ISL3175EIUZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3176EIBZ                                                               | 3176EIBZ     | 14 Ld SOIC                              | M14.15      | Tube                     |              |
| ISL3176EIBZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3176EIUZ                                                               | 3176Z        | 10 Ld MSOP                              | M10.118     | Tube                     |              |
| ISL3176EIUZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3176EIUZ-T7A                                                           |              |                                         |             | Reel, 250                |              |
| ISL3177EIBZ                                                               | 3177<br>EIBZ | 8 Ld SOIC                               | M8.15       | Tube                     |              |
| ISL3177EIBZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |
| ISL3177EIUZ                                                               | 3177Z        | 8 Ld MSOP                               | M8.118      | Tube                     |              |
| ISL3177EIUZ-T                                                             |              |                                         |             | Reel, 2.5k               |              |

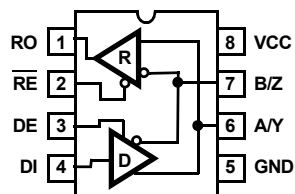
| PART NUMBER<br>(Notes 2, 3) | PART MARKING | PACKAGE DESCRIPTION<br>(RoHS Compliant) | PKG. DWG. # | CARRIER TYPE<br>(Note 1) | TEMP. RANGE  |
|-----------------------------|--------------|-----------------------------------------|-------------|--------------------------|--------------|
| ISL3178EIBZ                 | 3178<br>EIBZ | 8 Ld SOIC                               | M8.15       | Tube                     | -40 to +85°C |
| ISL3178EIBZ-T               |              |                                         |             | Reel, 2.5k               |              |
| ISL3178EIBZ-T7A             |              |                                         |             | Reel, 250                |              |
| ISL3178EIUZ                 | 3178Z        | 8 Ld MSOP                               | M8.118      | Tube                     |              |
| ISL3178EIUZ-T               |              |                                         |             | Reel, 2.5k               |              |

## NOTES:

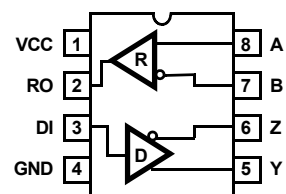
1. See [TB347](#) for details about reel specifications.
2. These Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
3. For Moisture Sensitivity Level (MSL), see the product information page for the [ISL3170E](#), [ISL3171E](#), [ISL3172E](#), [ISL3173E](#), [ISL3174E](#), [ISL3175E](#), [ISL3176E](#), [ISL3177E](#), [ISL3178E](#). For more information on MSL refer to [TB363](#).

## Pinouts

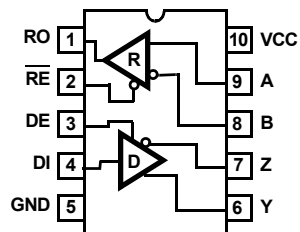
ISL3172E, ISL3175E, ISL3178E  
(8 LD MSOP, SOIC)  
TOP VIEW



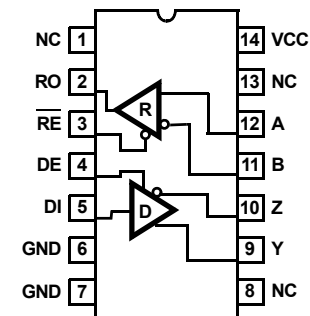
ISL3171E, ISL3174E, ISL3177E  
(8 LD MSOP, SOIC)  
TOP VIEW



ISL3170E, ISL3173E, ISL3176E  
(10 LD MSOP)  
TOP VIEW



ISL3170E, ISL3173E, ISL3176E  
(14 LD SOIC)  
TOP VIEW



## Truth Tables

| TRANSMITTING |    |    |         |         |
|--------------|----|----|---------|---------|
| INPUTS       |    |    | OUTPUTS |         |
| RE           | DE | DI | Z       | Y       |
| X            | 1  | 1  | 0       | 1       |
| X            | 1  | 0  | 1       | 0       |
| 0            | 0  | X  | High-Z  | High-Z  |
| 1            | 0  | X  | High-Z* | High-Z* |

NOTE: \*Shutdown Mode (see [Note 10](#) on [page 10](#)), except for the ISL3171E, ISL3174E, ISL3177E.

| RECEIVING |                   |                   |                           |              |
|-----------|-------------------|-------------------|---------------------------|--------------|
| INPUTS    |                   |                   |                           | OUTPUT       |
| RE        | DE<br>Half Duplex | DE<br>Full Duplex | A-B                       | RO           |
| 0         | 0                 | X                 | $V_{AB} \geq -0.05V$      | 1            |
| 0         | 0                 | X                 | $-0.05V > V_{AB} > -0.2V$ | Undetermined |
| 0         | 0                 | X                 | $V_{AB} \leq -0.2V$       | 0            |
| 0         | 0                 | X                 | Inputs Open/Shorted       | 1            |
| 1         | 0                 | X                 | X                         | High-Z*      |
| 1         | 1                 | X                 | X                         | High-Z       |

NOTE: \*Shutdown Mode (see [Note 10](#)), except for the ISL3171E, ISL3174E, ISL3177E.

## Pin Descriptions

| PIN                    | FUNCTION                                                                                                                                                                                                                                                                                           |
|------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| RO                     | Receiver output: If $A-B \geq -50\text{mV}$ , RO is high; If $A-B \leq -200\text{mV}$ , RO is low; if A and B are unconnected (floating) or shorted, RO = High.                                                                                                                                    |
| $\overline{\text{RE}}$ | Receiver output enable. RO is enabled when $\overline{\text{RE}}$ is low; RO is high impedance when $\overline{\text{RE}}$ is high. If the Rx enable function is not required, connect $\overline{\text{RE}}$ directly to GND or through a $1\text{k}\Omega$ to $3\text{k}\Omega$ resistor to GND. |
| DE                     | Driver output enable. The driver outputs, Y and Z, are enabled by bringing DE high, and are high impedance when DE is low. If the Tx enable function is not required, connect DE to $V_{\text{CC}}$ through a $1\text{k}\Omega$ to $3\text{k}\Omega$ resistor.                                     |
| DI                     | Driver input. A low on DI forces output Y low and output Z high. Similarly, a high on DI forces output Y high and output Z low.                                                                                                                                                                    |
| GND                    | Ground connection.                                                                                                                                                                                                                                                                                 |
| A/Y                    | $\pm 15\text{kV}$ IEC61000 ESD Protected RS-485/422 level, noninverting receiver input and noninverting driver output. Pin is an input if DE = 0; pin is an output if DE = 1.                                                                                                                      |
| B/Z                    | $\pm 15\text{kV}$ IEC61000 ESD Protected RS-485/422 level, Inverting receiver input and inverting driver output. Pin is an input if DE = 0; pin is an output if DE = 1.                                                                                                                            |
| A                      | $\pm 15\text{kV}$ IEC61000 ESD Protected RS-485/422 level, noninverting receiver input.                                                                                                                                                                                                            |
| B                      | $\pm 15\text{kV}$ IEC61000 ESD Protected RS-485/422 level, inverting receiver input.                                                                                                                                                                                                               |
| Y                      | $\pm 15\text{kV}$ IEC61000 ESD Protected RS-485/422 level, noninverting driver output.                                                                                                                                                                                                             |
| Z                      | $\pm 15\text{kV}$ IEC61000 ESD Protected RS-485/422 level, inverting driver output.                                                                                                                                                                                                                |
| $V_{\text{CC}}$        | System power supply input (3.0V to 3.6V).                                                                                                                                                                                                                                                          |
| NC                     | No Connection.                                                                                                                                                                                                                                                                                     |

## Typical Operating Circuits

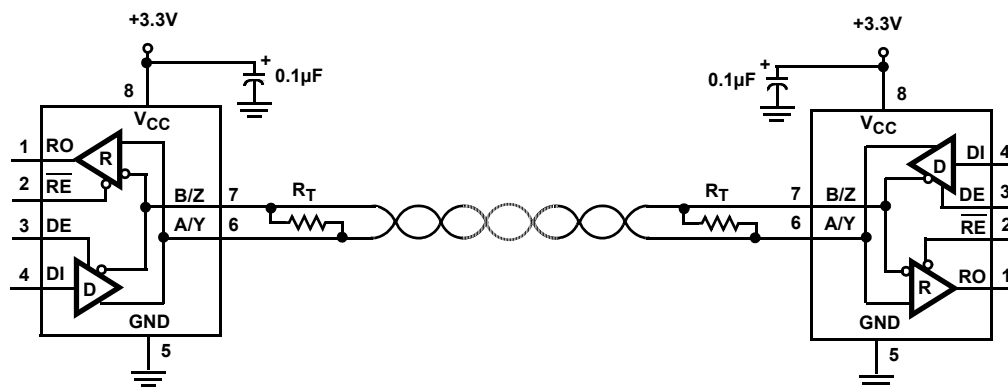


FIGURE 1. ISL3172E, ISL3175E, ISL3178E

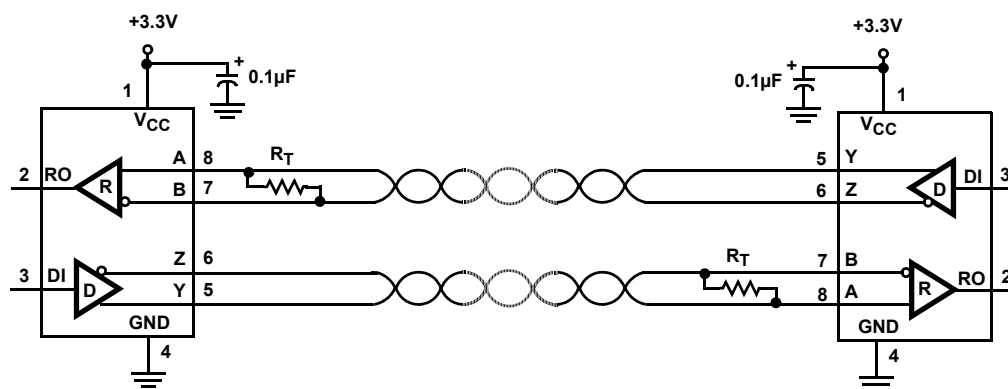


FIGURE 2. ISL3171E, ISL3174E, ISL3177E

# **Typical Operating Circuits** (Continued)

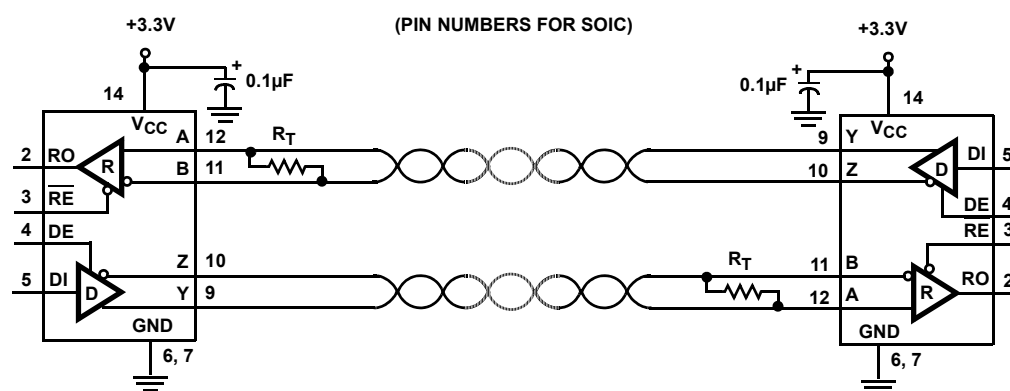


FIGURE 3. ISL3170E, ISL3173E, ISL3176E

**Absolute Maximum Ratings**

|                        |                                     |
|------------------------|-------------------------------------|
| $V_{CC}$ to GND        | 7V                                  |
| Input Voltages         |                                     |
| DI                     | -0.3V to 7V                         |
| DE, RE (Note 20)       | -0.3V to 7V                         |
| Input/Output Voltages  |                                     |
| A, B, Y, Z             | -8V to +13V                         |
| RO                     | -0.3V to ( $V_{CC}$ + 0.3V)         |
| Short Circuit Duration |                                     |
| Y, Z                   | Continuous                          |
| ESD Rating             | See Electrical Specifications Table |

**Thermal Information**

|                                                |                      |
|------------------------------------------------|----------------------|
| Thermal Resistance (Typical, Note 4)           | $\theta_{JA}$ (°C/W) |
| 8 Ld SOIC Package                              | 105                  |
| 8 Ld MSOP Package                              | 140                  |
| 10 Ld MSOP Package                             | 190                  |
| 14 Ld SOIC Package                             | 128                  |
| Maximum Junction Temperature (Plastic Package) | +150°C               |
| Maximum Storage Temperature Range              | -65°C to +150°C      |
| Pb-Free Reflow Profile                         | see TB493            |

**Operating Conditions**

|                   |                |
|-------------------|----------------|
| Temperature Range | -40°C to +85°C |
|-------------------|----------------|

**CAUTION:** Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTE:

4.  $\theta_{JA}$  is measured with the component mounted on a high-effective thermal conductivity test board in free air. Refer to TB379 for details.

**Electrical Specifications** Test Conditions:  $V_{CC}$  = 3.0V to 3.6V; unless otherwise specified. Typicals are at  $V_{CC}$  = 3.3V,  $T_A$  = +25°C, (Note 5)

| PARAMETER                                                                            | SYMBOL          | TEST CONDITIONS                                             | TEMP (°C)      | MIN (Note 19) | TYP  | MAX (Note 19) | UNITS  |
|--------------------------------------------------------------------------------------|-----------------|-------------------------------------------------------------|----------------|---------------|------|---------------|--------|
| <b>DC CHARACTERISTICS</b>                                                            |                 |                                                             |                |               |      |               |        |
| Driver Differential $V_{OUT}$                                                        | $V_{OD}$        | $R_L$ = 100Ω (RS-422) (Figure 4A, Note 16)                  | Full           | 2             | 2.3  | -             | V      |
|                                                                                      |                 | $R_L$ = 54Ω (RS-485) (Figure 4A)                            | Full           | 1.5           | 2    | $V_{CC}$      | V      |
|                                                                                      |                 | No Load                                                     |                | -             | -    | $V_{CC}$      |        |
|                                                                                      |                 | $R_L$ = 60Ω, -7V ≤ $V_{CM}$ ≤ 12V (Figure 4B)               | Full           | 1.5           | 2.2  | -             | V      |
| Change in Magnitude of Driver Differential $V_{OUT}$ for Complementary Output States | $\Delta V_{OD}$ | $R_L$ = 54Ω or 100Ω (Figure 4A)                             | Full           | -             | 0.01 | 0.2           | V      |
| Driver Common-Mode $V_{OUT}$                                                         | $V_{OC}$        | $R_L$ = 54Ω or 100Ω (Figure 4A)                             | Full           | -             | 2    | 3             | V      |
| Change in Magnitude of Driver Common-Mode $V_{OUT}$ for Complementary Output States  | $\Delta V_{OC}$ | $R_L$ = 54Ω or 100Ω (Figure 4A)                             | Full           | -             | 0.01 | 0.2           | V      |
| Logic Input High Voltage                                                             | $V_{IH}$        | DI, DE, $\overline{RE}$                                     | Full           | 2             | -    | -             | V      |
| Logic Input Low Voltage                                                              | $V_{IL}$        | DI, DE, $\overline{RE}$                                     | Full           | -             | -    | 0.8           | V      |
| Logic Input Hysteresis                                                               | $V_{HYS}$       | DE, $\overline{RE}$ (Note 15)                               | 25             | -             | 100  | -             | mV     |
| Logic Input Current                                                                  | $I_{IN1}$       | DI = DE = $\overline{RE}$ = 0V or $V_{CC}$ (Note 18)        | Full           | -2            | -    | 2             | μA     |
| Input Current (A, B, A/Y, B/Z)                                                       | $I_{IN2}$       | DE = 0V, $V_{CC}$ = 0V or 3.6V                              | $V_{IN}$ = 12V | Full          | -    | 80            | 125 μA |
|                                                                                      |                 |                                                             | $V_{IN}$ = -7V | Full          | -100 | -50           | - μA   |
| Output Leakage Current (Y, Z) (Full Duplex Versions Only, Note 13)                   | $I_{IN3}$       | $\overline{RE}$ = 0V, DE = 0V, $V_{CC}$ = 0V or 3.6V        | $V_{IN}$ = 12V | Full          | -    | 10            | 40 μA  |
|                                                                                      |                 |                                                             | $V_{IN}$ = -7V | Full          | -40  | -10           | - μA   |
| Output Leakage Current (Y, Z) in Shutdown Mode (Full Duplex, Note 13)                | $I_{IN4}$       | $\overline{RE}$ = $V_{CC}$ , DE = 0V, $V_{CC}$ = 0V or 3.6V | $V_{IN}$ = 12V | Full          | -    | 10            | 40 μA  |
|                                                                                      |                 |                                                             | $V_{IN}$ = -7V | Full          | -40  | -10           | - μA   |
| Driver Short-Circuit Current, $V_O$ = High or Low                                    | $I_{OSD1}$      | DE = $V_{CC}$ , -7V ≤ $V_Y$ or $V_Z$ ≤ 12V (Note 7)         | Full           | -             | -    | ±250          | mA     |
| Receiver Differential Threshold Voltage                                              | $V_{TH}$        | -7V ≤ $V_{CM}$ ≤ 12V                                        | Full           | -200          | -125 | -50           | mV     |
| Receiver Input Hysteresis                                                            | $\Delta V_{TH}$ | $V_{CM}$ = 0V                                               | 25             | -             | 15   | -             | mV     |

**Electrical Specifications** Test Conditions:  $V_{CC} = 3.0V$  to  $3.6V$ ; unless otherwise specified. Typicals are at  $V_{CC} = 3.3V$ ,  $T_A = +25^{\circ}C$ , (Note 5)

| PARAMETER                                                                           | SYMBOL                          | TEST CONDITIONS                                                                                                                                                         |                                                      | TEMP<br>(°C) | MIN<br>( <a href="#">Note 19</a> ) | TYP   | MAX<br>( <a href="#">Note 19</a> ) | UNITS |
|-------------------------------------------------------------------------------------|---------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------|--------------|------------------------------------|-------|------------------------------------|-------|
| Receiver Output High Voltage                                                        | V <sub>OH</sub>                 | I <sub>O</sub> = -4mA, V <sub>ID</sub> = -50mV                                                                                                                          |                                                      | Full         | V <sub>CC</sub> - 0.6              | -     | -                                  | V     |
| Receiver Output Low Voltage                                                         | V <sub>OL</sub>                 | I <sub>O</sub> = -4mA, V <sub>ID</sub> = -200mV                                                                                                                         |                                                      | Full         | -                                  | 0.17  | 0.4                                | V     |
| Three-State (high impedance)<br>Receiver Output Current ( <a href="#">Note 13</a> ) | I <sub>OZR</sub>                | 0.4V ≤ V <sub>O</sub> ≤ 2.4V                                                                                                                                            |                                                      | Full         | -1                                 | 0.015 | 1                                  | μA    |
| Receiver Input Resistance                                                           | R <sub>IN</sub>                 | -7V ≤ V <sub>CM</sub> ≤ 12V                                                                                                                                             |                                                      | Full         | 96                                 | 150   | -                                  | kΩ    |
| Receiver Short-Circuit Current                                                      | I <sub>OSR</sub>                | 0V ≤ V <sub>O</sub> ≤ V <sub>CC</sub>                                                                                                                                   |                                                      | Full         | ±7                                 | 30    | ±60                                | mA    |
| Thermal Shutdown Threshold                                                          | T <sub>SD</sub>                 |                                                                                                                                                                         |                                                      | Full         | -                                  | 150   | -                                  | °C    |
| SUPPLY CURRENT                                                                      |                                 |                                                                                                                                                                         |                                                      |              |                                    |       |                                    |       |
| No-Load Supply Current ( <a href="#">Note 6</a> )                                   | I <sub>CC</sub>                 | DI = 0V or V <sub>CC</sub>                                                                                                                                              | DE = V <sub>CC</sub> ,<br>RE = 0V or V <sub>CC</sub> | Full         | -                                  | 510   | 800                                | μA    |
|                                                                                     |                                 |                                                                                                                                                                         | DE = 0V, RE = 0V                                     | Full         | -                                  | 480   | 700                                | μA    |
| Shutdown Supply Current<br>( <a href="#">Note 13</a> )                              | I <sub>SHDN</sub>               | DE = 0V, RE = V <sub>CC</sub> , DI = 0V or V <sub>CC</sub>                                                                                                              |                                                      | Full         | -                                  | 0.01  | 12                                 | μA    |
| ESD PERFORMANCE                                                                     |                                 |                                                                                                                                                                         |                                                      |              |                                    |       |                                    |       |
| RS-485 Pins (A, Y, B, Z, A/Y, B/Z)                                                  |                                 | IEC61000-4-2, Air-Gap Discharge Method                                                                                                                                  |                                                      | 25           | -                                  | ±15   | -                                  | kV    |
|                                                                                     |                                 | IEC61000-4-2, Contact Discharge Method                                                                                                                                  |                                                      | 25           | -                                  | ±8    | -                                  | kV    |
|                                                                                     |                                 | Human Body Model, from bus pins to GND                                                                                                                                  |                                                      | 25           | -                                  | ±15   | -                                  | kV    |
| All Pins                                                                            |                                 | HBM, per MIL-STD-883 Method 3015                                                                                                                                        |                                                      | 25           | -                                  | ±7    | -                                  | kV    |
|                                                                                     |                                 | Machine Model                                                                                                                                                           |                                                      | 25           | -                                  | 200   | -                                  | V     |
| DRIVER SWITCHING CHARACTERISTICS (ISL3170E, ISL3171E, ISL3172E, 250kbps)            |                                 |                                                                                                                                                                         |                                                      |              |                                    |       |                                    |       |
| Maximum Data Rate                                                                   | f <sub>MAX</sub>                | V <sub>OD</sub> = ±1.5V, C <sub>D</sub> = 820pF ( <a href="#">Figure 7</a> , <a href="#">Note 17</a> )                                                                  |                                                      | Full         | 250                                | 800   | -                                  | kbps  |
| Driver Differential Output Delay                                                    | t <sub>DD</sub>                 | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> )                                                                                             |                                                      | Full         | 250                                | 1100  | 1500                               | ns    |
| Driver Differential Output Skew                                                     | t <sub>SKEW</sub>               | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> )                                                                                             |                                                      | Full         | -                                  | 6     | 100                                | ns    |
| Driver Differential Rise or Fall Time                                               | t <sub>R</sub> , t <sub>F</sub> | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> )                                                                                             |                                                      | Full         | 350                                | 960   | 1600                               | ns    |
| Driver Enable to Output High                                                        | t <sub>ZH</sub>                 | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = GND<br>( <a href="#">Figure 6</a> , <a href="#">Notes 8</a> , <a href="#">13</a> )                                   |                                                      | Full         | -                                  | 26    | 600                                | ns    |
| Driver Enable to Output Low                                                         | t <sub>ZL</sub>                 | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = V <sub>CC</sub><br>( <a href="#">Figure 6</a> , <a href="#">Notes 8</a> , <a href="#">13</a> )                       |                                                      | Full         | -                                  | 200   | 600                                | ns    |
| Driver Disable from Output High                                                     | t <sub>HZ</sub>                 | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = GND<br>( <a href="#">Figure 6</a> , <a href="#">Note 13</a> )                                                        |                                                      | Full         | -                                  | 28    | 55                                 | ns    |
| Driver Disable from Output Low                                                      | t <sub>LZ</sub>                 | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = V <sub>CC</sub><br>( <a href="#">Figure 6</a> , <a href="#">Note 13</a> )                                            |                                                      | Full         | -                                  | 30    | 55                                 | ns    |
| Time to Shutdown                                                                    | t <sub>SHDN</sub>               | <a href="#">(Notes 10</a> , <a href="#">13</a> )                                                                                                                        |                                                      | Full         | 50                                 | 200   | 600                                | ns    |
| Driver Enable from Shutdown to Output High                                          | t <sub>ZH(SHDN)</sub>           | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = GND<br>( <a href="#">Figure 6</a> , <a href="#">Notes 10</a> , <a href="#">11</a> , <a href="#">13</a> )             |                                                      | Full         | -                                  | 180   | 700                                | ns    |
| Driver Enable from Shutdown to Output Low                                           | t <sub>ZL(SHDN)</sub>           | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = V <sub>CC</sub><br>( <a href="#">Figure 6</a> , <a href="#">Notes 10</a> , <a href="#">11</a> , <a href="#">13</a> ) |                                                      | Full         | -                                  | 100   | 700                                | ns    |
| DRIVER SWITCHING CHARACTERISTICS (ISL3173E, ISL3174E, ISL3175E, 500kbps)            |                                 |                                                                                                                                                                         |                                                      |              |                                    |       |                                    |       |
| Maximum Data Rate                                                                   | f <sub>MAX</sub>                | V <sub>OD</sub> = ±1.5V, C <sub>D</sub> = 820pF ( <a href="#">Figure 7</a> , <a href="#">Note 17</a> )                                                                  |                                                      | Full         | 500                                | 1600  | -                                  | kbps  |
| Driver Differential Output Delay                                                    | t <sub>DD</sub>                 | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> )                                                                                             |                                                      | Full         | 180                                | 350   | 800                                | ns    |
| Driver Differential Output Skew                                                     | t <sub>SKEW</sub>               | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> )                                                                                             |                                                      | Full         | -                                  | 1     | 30                                 | ns    |
| Driver Differential Rise or Fall Time                                               | t <sub>R</sub> , t <sub>F</sub> | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> )                                                                                             |                                                      | Full         | 200                                | 380   | 800                                | ns    |
| Driver Enable to Output High                                                        | t <sub>ZH</sub>                 | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = GND<br>( <a href="#">Figure 6</a> , <a href="#">Notes 8</a> , <a href="#">13</a> )                                   |                                                      | Full         | -                                  | 26    | 350                                | ns    |



**Electrical Specifications** Test Conditions:  $V_{CC} = 3.0V$  to  $3.6V$ ; unless otherwise specified. Typicals are at  $V_{CC} = 3.3V$ ,  $T_A = +25^{\circ}C$ , (Note 5)

| PARAMETER                                                               | SYMBOL                              | TEST CONDITIONS                                                                                                                                                         | TEMP<br>(°C) | MIN<br>( <a href="#">Note 19</a> ) | TYP | MAX<br>( <a href="#">Note 19</a> ) | UNITS |      |
|-------------------------------------------------------------------------|-------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------|------------------------------------|-----|------------------------------------|-------|------|
| Driver Enable to Output Low                                             | t <sub>ZL</sub>                     | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = V <sub>CC</sub><br>( <a href="#">Figure 6</a> , <a href="#">Notes 8</a> , <a href="#">13</a> )                       | Full         | -                                  | 100 | 350                                | ns    |      |
| Driver Disable from Output High                                         | t <sub>HZ</sub>                     | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = GND<br>( <a href="#">Figure 6</a> , <a href="#">Note 13</a> )                                                        | Full         | -                                  | 28  | 55                                 | ns    |      |
| Driver Disable from Output Low                                          | t <sub>LZ</sub>                     | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = V <sub>CC</sub><br>( <a href="#">Figure 6</a> , <a href="#">Note 13</a> )                                            | Full         | -                                  | 30  | 55                                 | ns    |      |
| Time to Shutdown                                                        | t <sub>SHDN</sub>                   | ( <a href="#">Notes 10</a> , <a href="#">13</a> )                                                                                                                       | Full         | 50                                 | 200 | 600                                | ns    |      |
| Driver Enable from Shutdown to Output High                              | t <sub>ZH</sub> (SHDN)              | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = GND<br>( <a href="#">Figure 6</a> , <a href="#">Notes 10</a> , <a href="#">11</a> , <a href="#">13</a> )             | Full         | -                                  | 180 | 700                                | ns    |      |
| Driver Enable from Shutdown to Output Low                               | t <sub>ZL</sub> (SHDN)              | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = V <sub>CC</sub><br>( <a href="#">Figure 6</a> , <a href="#">Notes 10</a> , <a href="#">11</a> , <a href="#">13</a> ) | Full         | -                                  | 100 | 700                                | ns    |      |
| DRIVER SWITCHING CHARACTERISTICS (ISL3176E, ISL3177E, ISL3178E, 20Mbps) |                                     |                                                                                                                                                                         |              |                                    |     |                                    |       |      |
| Maximum Data Rate                                                       | f <sub>MAX</sub>                    | V <sub>OD</sub> = ±1.5V, C <sub>D</sub> = 350pF<br>( <a href="#">Figure 7</a> , <a href="#">Note 17</a> )                                                               | Full         | 20                                 | 28  | -                                  | Mbps  |      |
| Driver Differential Output Delay                                        | t <sub>DD</sub>                     | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> )                                                                                             | Full         | -                                  | 27  | 40                                 | ns    |      |
| Driver Differential Output Skew                                         | t <sub>SKEW</sub>                   | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> )                                                                                             | Full         | -                                  | 1   | 3                                  | ns    |      |
| Driver Output Skew, Part-to-Part                                        | Δt <sub>DSKEW</sub>                 | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> , <a href="#">Note 14</a> )                                                                   | Full         | -                                  | -   | 11                                 | ns    |      |
| Driver Differential Rise or Fall Time                                   | t <sub>R</sub> , t <sub>F</sub>     | R <sub>DIFF</sub> = 54Ω, C <sub>D</sub> = 50pF ( <a href="#">Figure 5</a> )                                                                                             | Full         | -                                  | 9   | 15                                 | ns    |      |
| Driver Enable to Output High                                            | t <sub>ZH</sub>                     | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = GND<br>( <a href="#">Figure 6</a> , <a href="#">Notes 8</a> , <a href="#">13</a> )                                   | Full         | -                                  | 17  | 50                                 | ns    |      |
| Driver Enable to Output Low                                             | t <sub>ZL</sub>                     | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = V <sub>CC</sub><br>( <a href="#">Figure 6</a> , <a href="#">Notes 8</a> , <a href="#">13</a> )                       | Full         | -                                  | 16  | 40                                 | ns    |      |
| Driver Disable from Output High                                         | t <sub>HZ</sub>                     | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = GND<br>( <a href="#">Figure 6</a> , <a href="#">Note 13</a> )                                                        | Full         | -                                  | 25  | 40                                 | ns    |      |
| Driver Disable from Output Low                                          | t <sub>LZ</sub>                     | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = V <sub>CC</sub><br>( <a href="#">Figure 6</a> , <a href="#">Note 13</a> )                                            | Full         | -                                  | 28  | 50                                 | ns    |      |
| Time to Shutdown                                                        | t <sub>SHDN</sub>                   | ( <a href="#">Notes 10</a> , <a href="#">13</a> )                                                                                                                       | Full         | 50                                 | 200 | 600                                | ns    |      |
| Driver Enable from Shutdown to Output High                              | t <sub>ZH</sub> (SHDN)              | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = GND<br>( <a href="#">Figure 6</a> , <a href="#">Notes 10</a> , <a href="#">11</a> , <a href="#">13</a> )             | Full         | -                                  | 180 | 700                                | ns    |      |
| Driver Enable from Shutdown to Output Low                               | t <sub>ZL</sub> (SHDN)              | R <sub>L</sub> = 500Ω, C <sub>L</sub> = 50pF, SW = V <sub>CC</sub><br>( <a href="#">Figure 6</a> , <a href="#">Notes 10</a> , <a href="#">11</a> , <a href="#">13</a> ) | Full         | -                                  | 90  | 700                                | ns    |      |
| RECEIVER SWITCHING CHARACTERISTICS (All Versions)                       |                                     |                                                                                                                                                                         |              |                                    |     |                                    |       |      |
| Maximum Data Rate                                                       | f <sub>MAX</sub>                    | V <sub>ID</sub> = ±1.5V ( <a href="#">Note 17</a> )                                                                                                                     | ISL3170E-75E | Full                               | 12  | 20                                 | -     | Mbps |
|                                                                         |                                     |                                                                                                                                                                         | ISL3176E-78E | Full                               | 20  | 35                                 | -     | Mbps |
| Receiver Input to Output Delay                                          | t <sub>PLH</sub> , t <sub>PHL</sub> | ( <a href="#">Figure 8</a> )                                                                                                                                            | ISL3170E-75E | Full                               | 25  | 70                                 | 120   | ns   |
|                                                                         |                                     |                                                                                                                                                                         | ISL3176E-78E | Full                               | 25  | 33                                 | 60    | ns   |
| Receiver Skew   t <sub>PLH</sub> - t <sub>PHL</sub>                     | t <sub>SKD</sub>                    | ( <a href="#">Figure 8</a> )                                                                                                                                            |              | Full                               | -   | 1.5                                | 4     | ns   |
| Receiver Skew, Part-to-Part                                             | Δt <sub>RSKEW</sub>                 | ( <a href="#">Figure 8</a> , <a href="#">Note 14</a> )                                                                                                                  |              | Full                               | -   | -                                  | 15    | ns   |
| Receiver Enable to Output High                                          | t <sub>ZH</sub>                     | R <sub>L</sub> = 1kΩ, C <sub>L</sub> = 15pF, SW = GND ( <a href="#">Figure 9</a> , <a href="#">Notes 9</a> , <a href="#">13</a> )                                       | ISL3170E-75E | Full                               | 5   | 15                                 | 20    | ns   |
|                                                                         |                                     |                                                                                                                                                                         | ISL3176E-78E | Full                               | 5   | 11                                 | 17    | ns   |
| Receiver Enable to Output Low                                           | t <sub>ZL</sub>                     | R <sub>L</sub> = 1kΩ, C <sub>L</sub> = 15pF, SW = V <sub>CC</sub> ( <a href="#">Figure 9</a> , <a href="#">Notes 9</a> , <a href="#">13</a> )                           | ISL3170E-75E | Full                               | 5   | 15                                 | 20    | ns   |
|                                                                         |                                     |                                                                                                                                                                         | ISL3176E-78E | Full                               | 5   | 11                                 | 17    | ns   |

**Electrical Specifications** Test Conditions:  $V_{CC} = 3.0V$  to  $3.6V$ ; unless otherwise specified. Typicals are at  $V_{CC} = 3.3V$ ,  $T_A = +25^{\circ}C$ , (Note 5)

| PARAMETER                                    | SYMBOL                 | TEST CONDITIONS                                                                                                                |              | TEMP<br>(°C) | MIN<br>( <a href="#">Note 19</a> ) | TYP | MAX<br>( <a href="#">Note 19</a> ) | UNITS |
|----------------------------------------------|------------------------|--------------------------------------------------------------------------------------------------------------------------------|--------------|--------------|------------------------------------|-----|------------------------------------|-------|
| Receiver Disable from Output High            | t <sub>HZ</sub>        | R <sub>L</sub> = 1kΩ, C <sub>L</sub> = 15pF,<br>SW = GND ( <a href="#">Figure 9</a> ,<br><a href="#">Note 13</a> )             | ISL3170E-75E | Full         | 5                                  | 12  | 20                                 | ns    |
|                                              |                        |                                                                                                                                | ISL3176E-78E | Full         | 4                                  | 7   | 15                                 | ns    |
| Receiver Disable from Output Low             | t <sub>LZ</sub>        | R <sub>L</sub> = 1kΩ, C <sub>L</sub> = 15pF,<br>SW = V <sub>CC</sub> ( <a href="#">Figure 9</a> ,<br><a href="#">Note 13</a> ) | ISL3170E-75E | Full         | 5                                  | 13  | 20                                 | ns    |
|                                              |                        |                                                                                                                                | ISL3176E-78E | Full         | 4                                  | 7   | 15                                 | ns    |
| Time to Shutdown                             | t <sub>SHDN</sub>      | <a href="#">(Notes 10, 13)</a>                                                                                                 |              | Full         | 50                                 | 180 | 600                                | ns    |
| Receiver Enable from Shutdown to Output High | t <sub>ZH</sub> (SHDN) | R <sub>L</sub> = 1kΩ, C <sub>L</sub> = 15pF, SW = GND<br><a href="#">(Figure 9, Notes 10, 12, 13)</a>                          |              | Full         | -                                  | 240 | 500                                | ns    |
| Receiver Enable from Shutdown to Output Low  | t <sub>ZL</sub> (SHDN) | R <sub>L</sub> = 1kΩ, C <sub>L</sub> = 15pF, SW = V <sub>CC</sub><br><a href="#">(Figure 9, Notes 10, 12, 13)</a>              |              | Full         | -                                  | 240 | 500                                | ns    |

## NOTES:

- All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to device ground unless otherwise specified.
- Supply current specification is valid for loaded drivers when  $DE = 0V$ .
- Applies to peak current. See "Typical Performance Curves" starting on page 15 for more information.
- When testing devices with the shutdown feature, keep  $\overline{RE} = 0$  to prevent the device from entering SHDN.
- When testing devices with the shutdown feature, the  $\overline{RE}$  signal high time must be short enough (typically  $<100ns$ ) to prevent the device from entering SHDN.
- Versions with a shutdown feature are put into shutdown by bringing  $\overline{RE}$  high and  $DE$  low. If the inputs are in this state for less than  $50ns$ , the parts are ensured not to enter shutdown. If the inputs are in this state for at least  $600ns$ , the parts are ensured to have entered shutdown. See "Low Power Shutdown Mode" on page 14.
- Keep  $\overline{RE} = V_{CC}$ , and set the  $DE$  signal low time  $>600ns$  to ensure that the device enters SHDN.
- Set the  $\overline{RE}$  signal high time  $>600ns$  to ensure that the device enters SHDN.
- Does not apply to the ISL3171E, ISL3174E, or ISL3177E.
- $\Delta t_{SKEW}$  is the magnitude of the difference in propagation delays of the specified terminals of two units tested with identical test conditions ( $V_{CC}$ , temperature, etc.). Applies only to the ISL3176E through ISL3178E.
- ISL3170E through ISL3175E only.
- $V_{CC} \geq 3.15V$ .
- Limits established by characterization and are not production tested.
- If the Tx or Rx enable function is not needed, connect the enable pin to the appropriate supply (see "Pin Descriptions" on page 5) through a  $1k\Omega$  to  $3k\Omega$  resistor.
- Parameters with MIN and/or MAX limits are 100% tested at  $+25^{\circ}C$ , unless otherwise specified. Temperature limits established by characterization and are not production tested.
- If the  $DE$  or  $\overline{RE}$  input voltage exceeds the  $V_{CC}$  voltage by more than  $500mV$ , then current will flow into the logic pin. The current is limited by a  $340\Omega$  resistor (so  $\approx 13mA$  with  $V_{IN} = 5V$  and  $V_{CC} = 0V$ ) so no damage will occur if  $V_{CC} \leq V_{IN} \leq 7V$  for short periods of time.

## Test Circuits and Waveforms

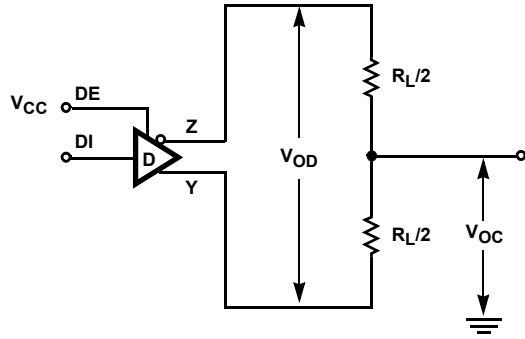


FIGURE 4A.  $V_{OD}$  AND  $V_{OC}$

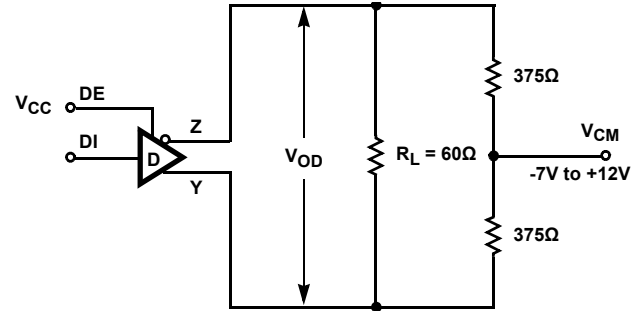


FIGURE 4B.  $V_{OD}$  WITH COMMON MODE LOAD

FIGURE 4. DC DRIVER TEST CIRCUITS

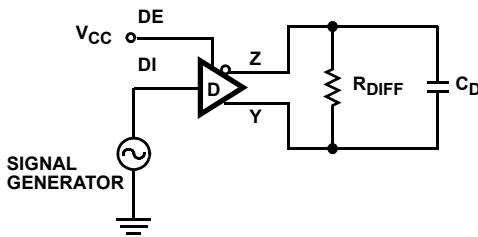


FIGURE 5A. TEST CIRCUIT

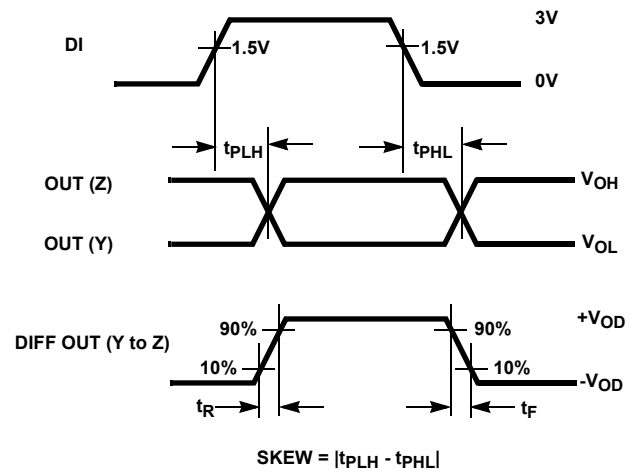
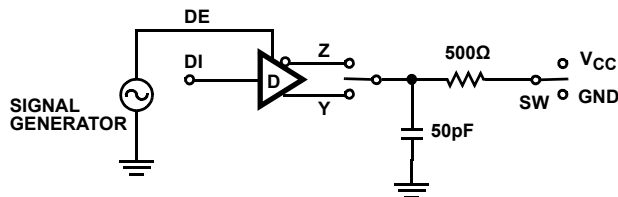


FIGURE 5B. MEASUREMENT POINTS

FIGURE 5. DRIVER PROPAGATION DELAY AND DIFFERENTIAL TRANSITION TIMES



| PARAMETER      | OUTPUT | $\overline{RE}$ | DI  | SW       |
|----------------|--------|-----------------|-----|----------|
| $t_{HZ}$       | Y/Z    | X               | 1/0 | GND      |
| $t_{LZ}$       | Y/Z    | X               | 0/1 | $V_{CC}$ |
| $t_{ZH}$       | Y/Z    | 0 (Note 8)      | 1/0 | GND      |
| $t_{ZL}$       | Y/Z    | 0 (Note 8)      | 0/1 | $V_{CC}$ |
| $t_{ZH}(SHDN)$ | Y/Z    | 1 (Note 11)     | 1/0 | GND      |
| $t_{ZL}(SHDN)$ | Y/Z    | 1 (Note 11)     | 0/1 | $V_{CC}$ |

FIGURE 6A. TEST CIRCUIT

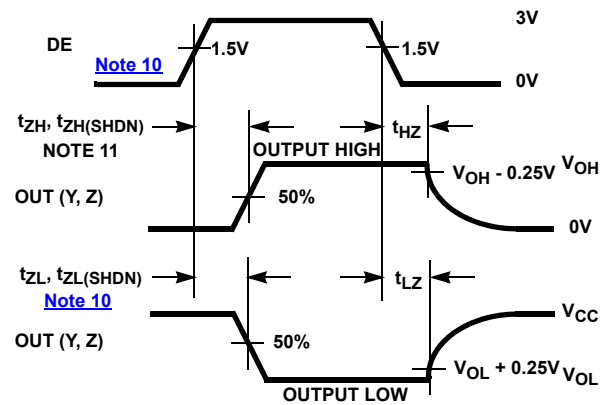


FIGURE 6B. MEASUREMENT POINTS

FIGURE 6. DRIVER ENABLE AND DISABLE TIMES (EXCEPT ISL3171E, ISL3174E, ISL3177E)

Test Circuits and Waveforms (Continued)

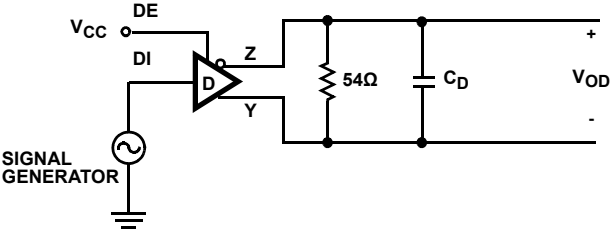


FIGURE 7A. TEST CIRCUIT

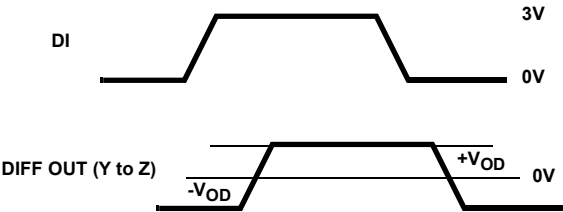


FIGURE 7B. MEASUREMENT POINTS

FIGURE 7. DRIVER DATA RATE

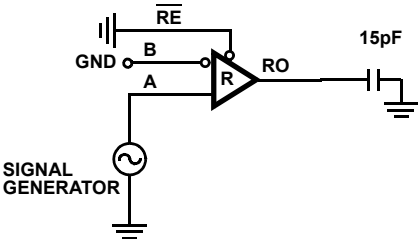


FIGURE 8A. TEST CIRCUIT

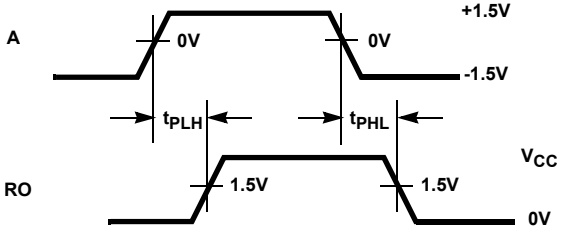
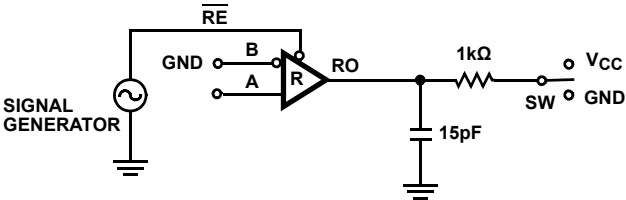


FIGURE 8B. MEASUREMENT POINTS

FIGURE 8. RECEIVER PROPAGATION DELAY



| PARAMETER                | DE | A     | SW       |
|--------------------------|----|-------|----------|
| $t_{HZ}$                 | X  | +1.5V | GND      |
| $t_{LZ}$                 | X  | -1.5V | $V_{CC}$ |
| $t_{ZH}$ (Note 9)        | 0  | +1.5V | GND      |
| $t_{ZL}$ (Note 9)        | 0  | -1.5V | $V_{CC}$ |
| $t_{ZH(SHDN)}$ (Note 12) | 0  | +1.5V | GND      |
| $t_{ZL(SHDN)}$ (Note 12) | 0  | -1.5V | $V_{CC}$ |

FIGURE 9A. TEST CIRCUIT

FIGURE 9. RECEIVER ENABLE AND DISABLE TIMES (EXCEPT ISL3171E, ISL3174E, ISL3177E)

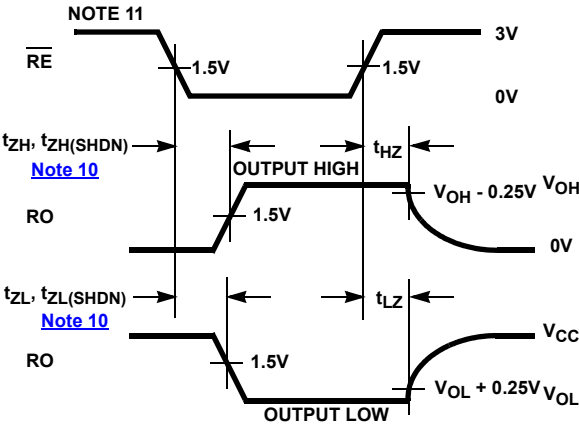


FIGURE 9B. MEASUREMENT POINTS

## Application Information

RS-485 and RS-422 are differential (balanced) data transmission standards for use in long haul or noisy environments. RS-422 is a subset of RS-485, so RS-485 transceivers are also RS-422 compliant. RS-422 is a point-to-multipoint (multidrop) standard, which allows only one driver and up to 10 receivers on each bus, assuming one unit load devices. RS-485 is a true multipoint standard, which allows up to 32 one-unit load devices (any combination of drivers and receivers) on each bus. To allow for multipoint operation, the RS-485 specification requires that drivers must handle bus contention without sustaining any damage.

Another important advantage of RS-485 is the extended common-mode range (CMR), which specifies that the driver outputs and receiver inputs withstand signals that range from +12V to -7V. RS-422 and RS-485 are intended for runs as long as 4000ft, so the wide CMR is necessary to handle ground potential differences, as well as voltages induced in the cable by external fields.

### Receiver Features

These devices utilize a differential input receiver for maximum noise immunity and common mode rejection. Input sensitivity is better than  $\pm 200\text{mV}$ , as required by the RS-422 and RS-485 specifications.

Receiver input resistance of  $96\text{k}\Omega$  surpasses the RS-422 specification of  $4\text{k}\Omega$  and is eight times the RS-485 "Unit Load (UL)" requirement of  $12\text{k}\Omega$  minimum. Thus, these products are known as "one-eighth UL" transceivers and there can be up to 256 of these devices on a network while still complying with the RS-485 loading specification.

Receiver inputs function with common-mode voltages as great as +9V/-7V outside the power supplies (that is, +12V and -7V), making them ideal for long networks where induced voltages and ground potential differences are realistic concerns.

All the receivers include a "Full Fail-Safe" function that guarantees a high level receiver output if the receiver inputs are unconnected (floating) or shorted. Fail-safe with shorted inputs is achieved by setting the Rx upper switching point to -50mV, thereby ensuring that the Rx sees 0V differential as a high input level.

Receivers easily meet the data rates supported by the corresponding driver, and all receiver outputs (except on the ISL3171E, ISL3174E, and ISL3177E) are tri-statable using the active low  $\overline{\text{RE}}$  input.

### Driver Features

The RS-485/422 driver is a differential output device that delivers at least 1.5V across a  $54\Omega$  load (RS-485) and at least 2V across a  $100\Omega$  load (RS-422). The drivers feature low propagation delay skew to maximize bit width and to minimize EMI.

All drivers are tri-statable through the active high DE input, except on the ISL3171E, ISL3174E, and ISL3177E.

The 250kbps and 500kbps driver outputs are slew rate limited to minimize EMI and to reduce reflections in unterminated or improperly terminated networks. Outputs of the ISL3176E through ISL3178E drivers are not limited, so faster output transition times allow data rates of at least 20Mbps.

### Hot Plug Function

When a piece of equipment powers up, a period of time occurs in which the processor or ASIC driving the RS-485 control lines (DE,  $\overline{\text{RE}}$ ) is unable to ensure that the RS-485 Tx and Rx outputs are kept disabled. If the equipment is connected to the bus, a driver activating prematurely during power up may crash the bus. To avoid this scenario, the ISL317XE versions with output enable pins incorporate a "Hot Plug" function. During power up, circuitry monitoring  $V_{\text{CC}}$  ensures that the Tx and Rx outputs remain disabled for a period of time, regardless of the state of DE and  $\overline{\text{RE}}$ . This gives the processor/ASIC a chance to stabilize and drive the RS-485 control lines to the proper states.

### ESD Protection

All pins on these devices include Class 3 (>7kV) Human Body Model (HBM) ESD protection structures, but the RS-485 pins (driver outputs and receiver inputs) incorporate advanced structures allowing them to survive ESD events in excess of  $\pm 15\text{kV}$  HBM and  $\pm 15\text{kV}$  IEC61000. The RS-485 pins are particularly vulnerable to ESD damage because they typically connect to an exposed port on the exterior of the finished product. Simply touching the port pins, or connecting a cable, can cause an ESD event that might destroy unprotected ICs. These new ESD structures protect the device whether or not it is powered up, and without degrading the RS-485 common mode range of -7V to +12V. This built-in ESD protection eliminates the need for board level protection structures (for example, transient suppression diodes), and the associated, undesirable capacitive load they present.

### IEC61000-4-2 Testing

The IEC61000 test method applies to finished equipment, rather than to an individual IC. Therefore, the pins most likely to suffer an ESD event are those that are exposed to the outside world (the RS-485 pins in this case), and the IC is tested in its typical application configuration (power applied) rather than testing each pin-to-pin combination. The lower current limiting resistor coupled with the larger charge storage capacitor yields a test that is much more severe than the HBM test. The extra ESD protection built into this device's RS-485 pins allows the design of equipment meeting Level 4 criteria without the need for additional board level protection on the RS-485 port.

**AIR-GAP DISCHARGE TEST METHOD**

For this test method, a charged probe tip moves toward the IC pin until the voltage arcs to it. The current waveform delivered to the IC pin depends on approach speed, humidity, temperature, etc., so it is difficult to obtain repeatable results. The ISL317XE RS-485 pins withstand  $\pm 15\text{kV}$  air-gap discharges.

**CONTACT DISCHARGE TEST METHOD**

During the contact discharge test, the probe contacts the tested pin before the probe tip is energized, thereby eliminating the variables associated with the air-gap discharge. The result is a more repeatable and predictable test, but equipment limits prevent testing devices at voltages higher than  $\pm 8\text{kV}$ . The ISL317XE survive  $\pm 8\text{kV}$  contact discharges on the RS-485 pins.

**Data Rate, Cables, and Terminations**

RS-485/422 are intended for network lengths up to 4000ft, but the maximum system data rate decreases as the transmission length increases. Devices operating at 20Mbps are limited to lengths less than 100ft, while the 250kbps versions can operate at full data rates with lengths of several thousand feet.

Twisted pair is the cable of choice for RS-485/422 networks. Twisted pair cables tend to pick up noise and other electromagnetically induced voltages as common mode signals, which are effectively rejected by the differential receivers in these ICs.

Proper termination is imperative when using the 20Mbps devices to minimize reflections. Short networks using the 250kbps versions do not need to be terminated, but terminations are recommended unless power dissipation is an overriding concern.

In point-to-point, or point-to-multipoint (single driver on bus) networks, the main cable should be terminated in its characteristic impedance (typically  $120\Omega$ ) at the end farthest from the driver. In multi-receiver applications, keep stubs connecting receivers to the main cable as short as possible. Multipoint (multi-driver) systems require that the main cable be terminated in its characteristic impedance at both ends. Keep stubs connecting a transceiver to the main cable as short as possible.

**Built-In Driver Overload Protection**

As stated previously, the RS-485 spec requires that drivers survive worst case bus contentions undamaged. These devices meet this requirement via driver output short circuit current limits, and on-chip thermal shutdown circuitry.

The driver output stages incorporate short circuit current limiting circuitry which ensures that the output current never exceeds the RS-485 spec, even at the common-mode voltage range extremes. Additionally, these devices utilize a foldback circuit which reduces the short circuit current, and thus the power dissipation, whenever the contending voltage exceeds either supply.

In the event of a major short circuit condition, devices use a thermal shutdown feature that disables the drivers whenever the die temperature becomes excessive. This eliminates the power dissipation, allowing the die to cool. The drivers automatically re-enable after the die temperature drops about  $15^\circ$ . If the contention persists, the thermal shutdown/re-enable cycle repeats until the fault is cleared. Receivers stay operational during thermal shutdown.

**Low Power Shutdown Mode**

These CMOS transceivers all use a fraction of the power required by their bipolar counterparts, but some also include a shutdown feature that reduces the already low quiescent  $I_{CC}$  to a 10nA trickle. These devices enter shutdown whenever the receiver and driver are *simultaneously* disabled ( $\overline{RE} = V_{CC}$  and  $DE = GND$ ) for a period of at least 600ns. Disabling both the driver and the receiver for less than 50ns guarantees that the transceiver will not enter shutdown.

Note that receiver and driver enable times increase when the transceiver enables from shutdown. Refer to [Notes 8](#) through [12](#) at the end of the "Electrical Specifications table" on [page 10](#), for more information.

## Typical Performance Curves $V_{CC} = 3.3V$ , $T_A = +25^\circ C$ , unless otherwise specified

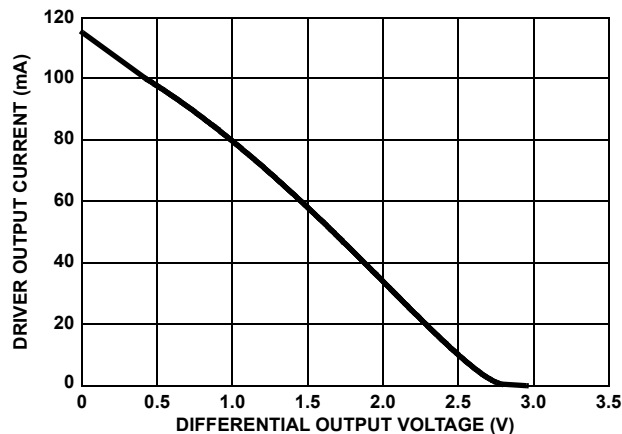


FIGURE 10. DRIVER OUTPUT CURRENT vs DIFFERENTIAL OUTPUT VOLTAGE

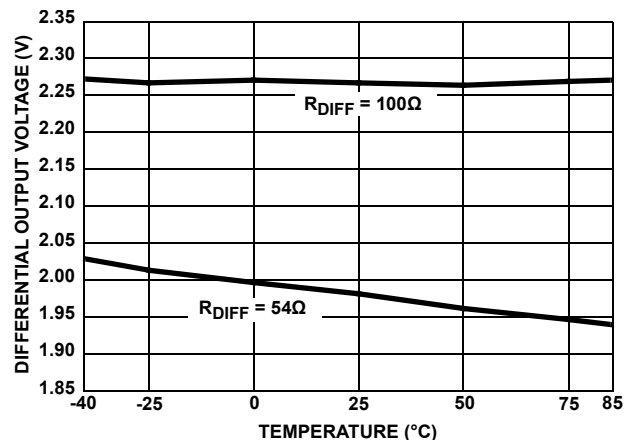


FIGURE 11. DRIVER DIFFERENTIAL OUTPUT VOLTAGE vs TEMPERATURE

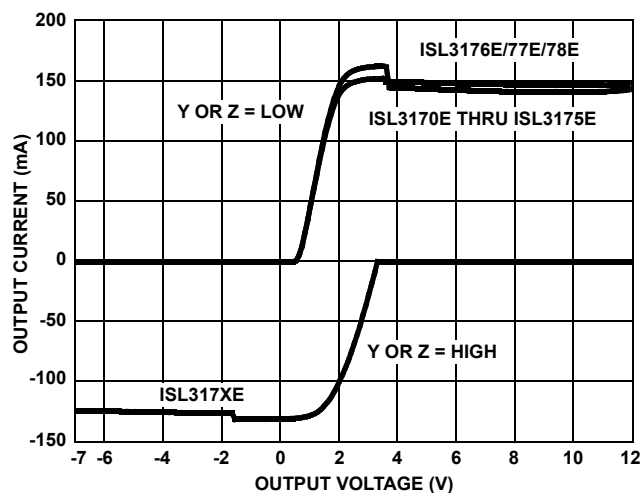


FIGURE 12. DRIVER OUTPUT CURRENT vs SHORT CIRCUIT VOLTAGE

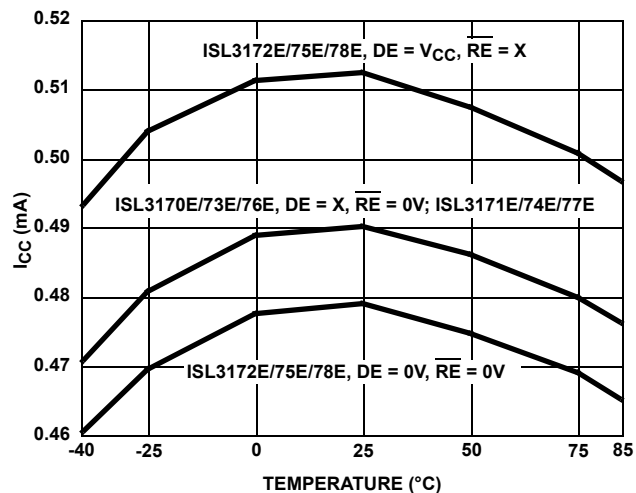


FIGURE 13. SUPPLY CURRENT vs TEMPERATURE

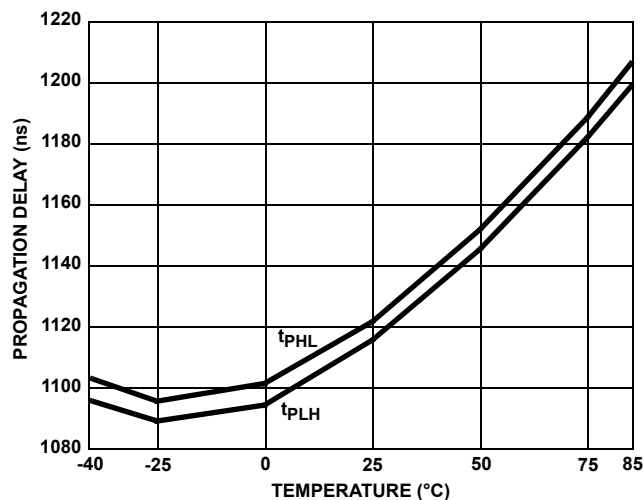


FIGURE 14. DRIVER DIFFERENTIAL PROPAGATION DELAY vs TEMPERATURE (ISL3170E, ISL3171E, ISL3172E)

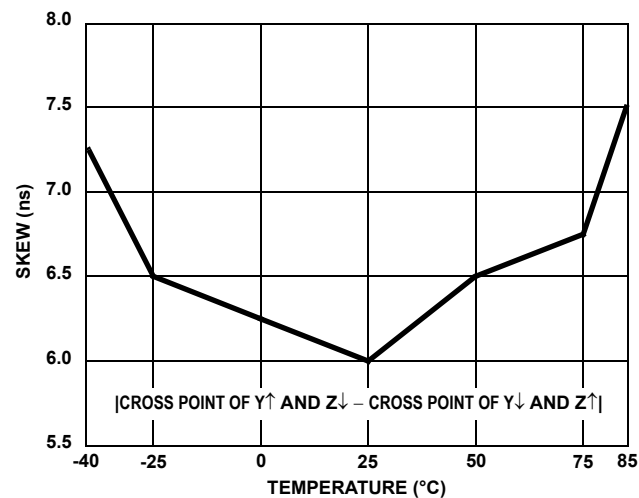
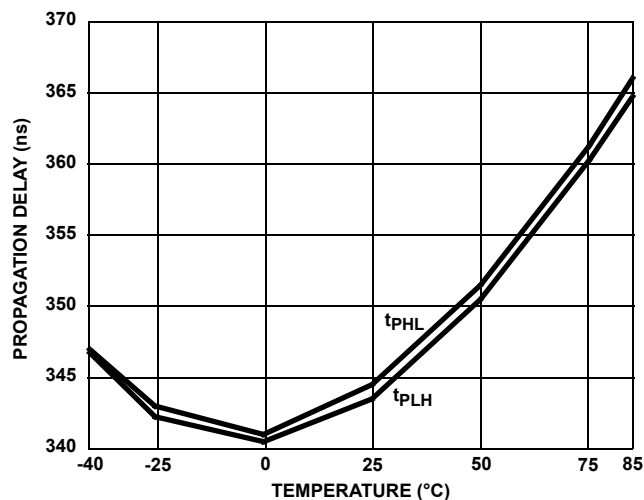
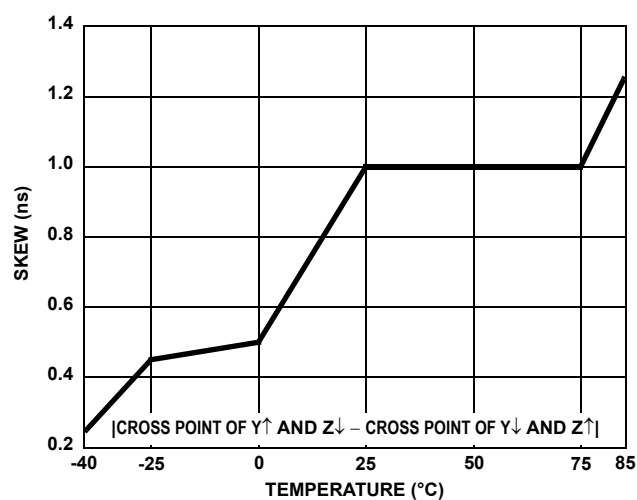


FIGURE 15. DRIVER DIFFERENTIAL SKEW vs TEMPERATURE (ISL3170E, ISL3171E, ISL3172E)

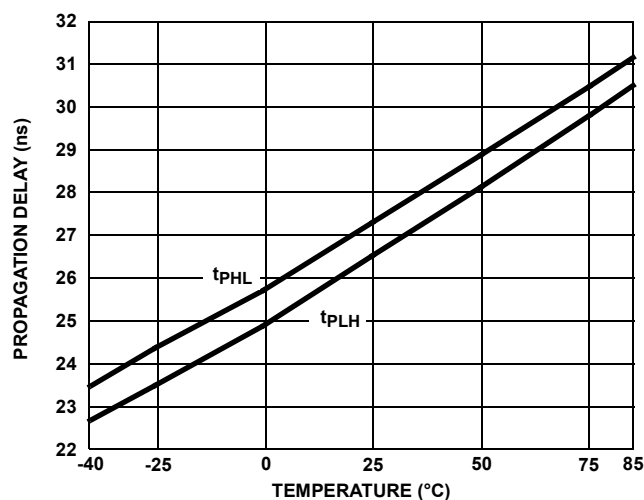
# **Typical Performance Curves** $V_{CC} = 3.3V$ , $T_A = +25^{\circ}C$ , unless otherwise specified (Continued)



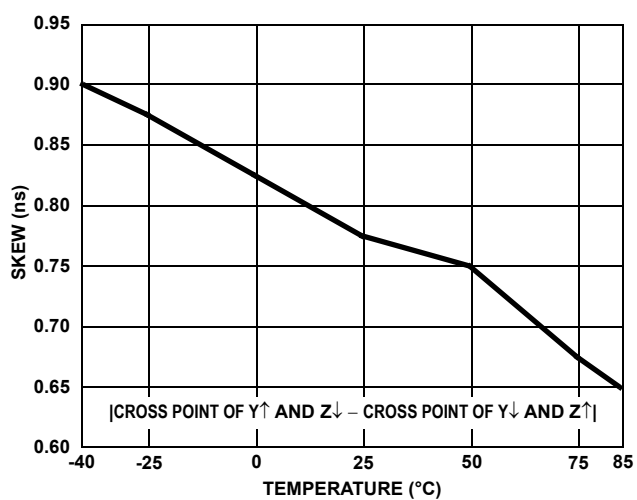
**FIGURE 16. DRIVER DIFFERENTIAL PROPAGATION DELAY vs TEMPERATURE (ISL3173E, ISL3174E, ISL3175E)**



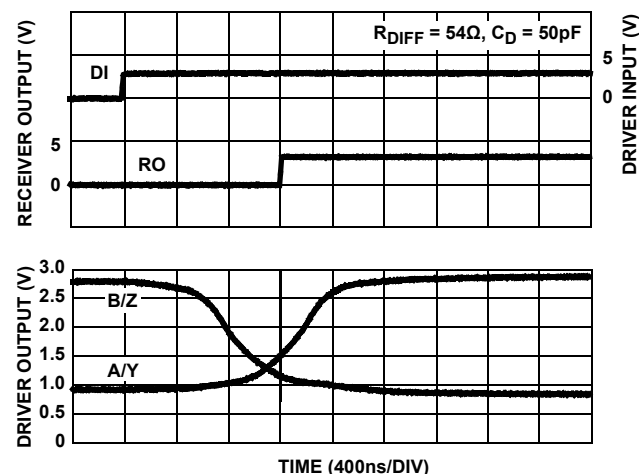
**FIGURE 17. DRIVER DIFFERENTIAL SKEW vs TEMPERATURE (ISL3173E, ISL3174E, ISL3175E)**



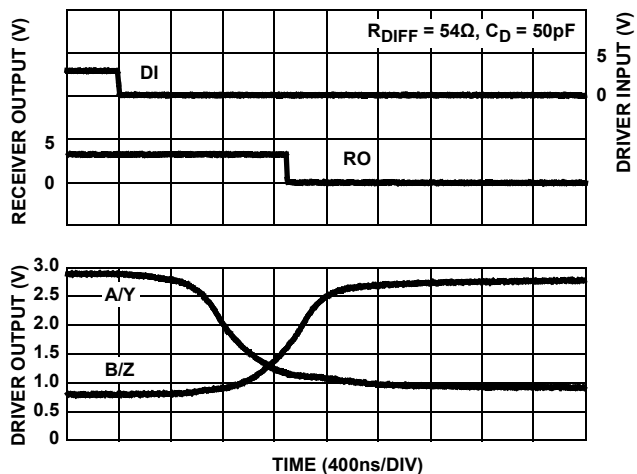
**FIGURE 18. DRIVER DIFFERENTIAL PROPAGATION DELAY vs TEMPERATURE (ISL3176E, ISL3177E, ISL3178E)**



**FIGURE 19. DRIVER DIFFERENTIAL SKEW vs TEMPERATURE (ISL3176E, ISL3177E, ISL3178E)**



**FIGURE 20. DRIVER AND RECEIVER WAVEFORMS, LOW TO HIGH (ISL3170E, ISL3171E, ISL3172E)**



**FIGURE 21. DRIVER AND RECEIVER WAVEFORMS, HIGH TO LOW (ISL3170E, ISL3171E, ISL3172E)**



# **Typical Performance Curves** $V_{CC} = 3.3V$ , $T_A = +25^\circ C$ , unless otherwise specified (Continued)

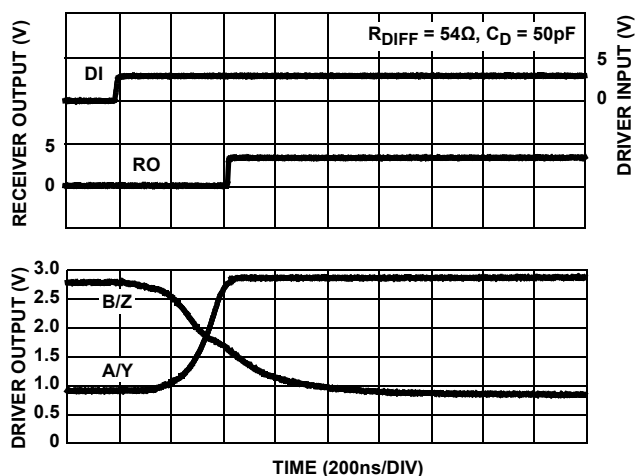


FIGURE 22. DRIVER AND RECEIVER WAVEFORMS, LOW TO HIGH (ISL3173E, ISL3174E, ISL3175E)

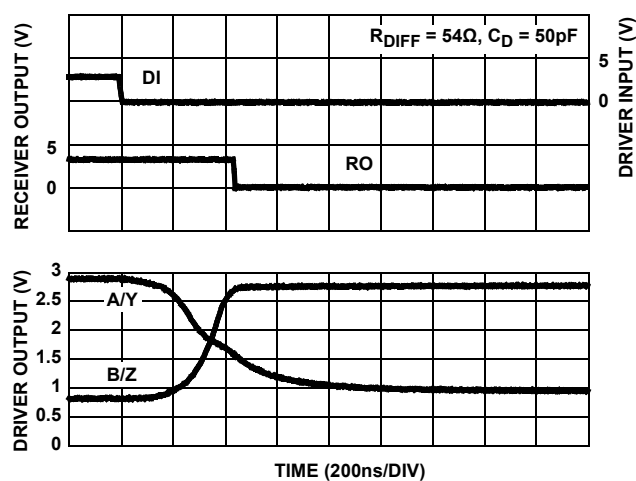


FIGURE 23. DRIVER AND RECEIVER WAVEFORMS, HIGH TO LOW (ISL3173E, ISL3174E, ISL3175E)

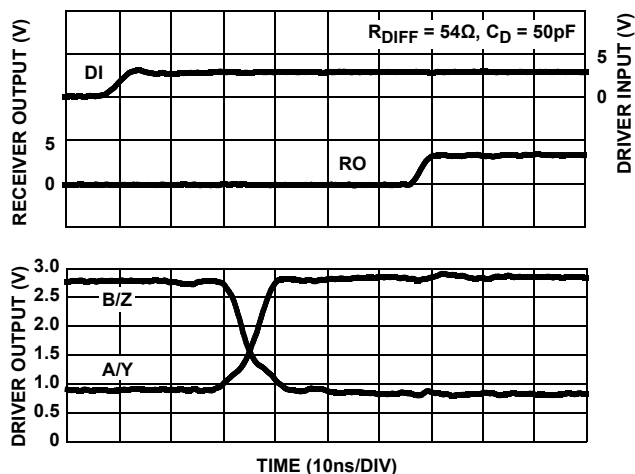


FIGURE 24. DRIVER AND RECEIVER WAVEFORMS, LOW TO HIGH (ISL3176E, ISL3177E, ISL3178E)

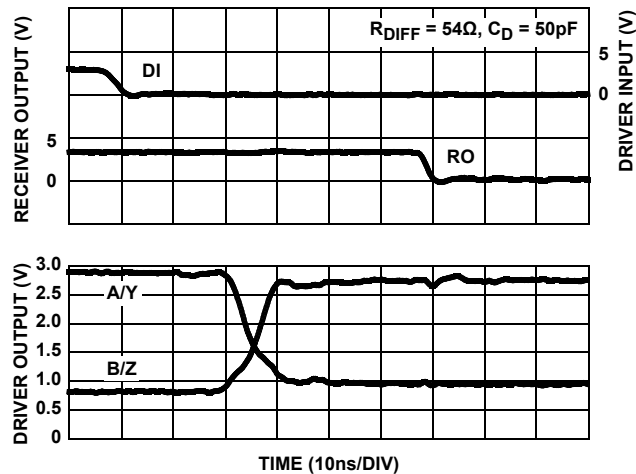


FIGURE 25. DRIVER AND RECEIVER WAVEFORMS, HIGH TO LOW (ISL3176E, ISL3177E, ISL3178E)

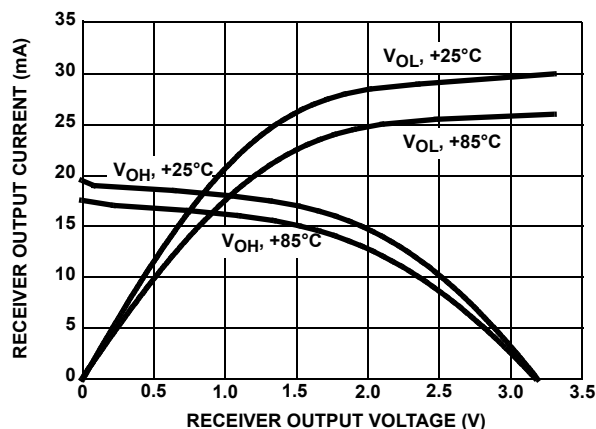


FIGURE 26. RECEIVER OUTPUT CURRENT vs RECEIVER OUTPUT VOLTAGE

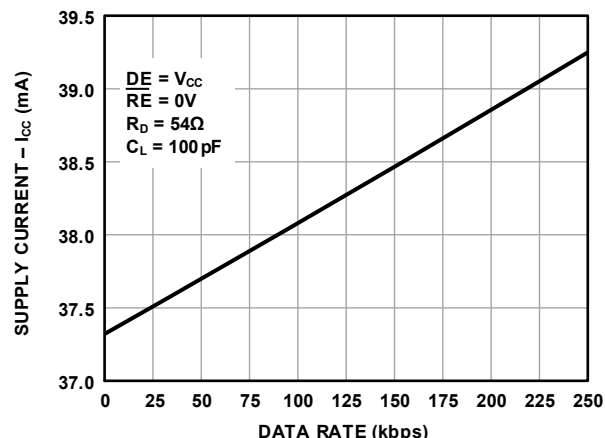


FIGURE 27. SUPPLY CURRENT vs DATA RATE (ISL3170E, ISL3172E)

## Typical Performance Curves $V_{CC} = 3.3V$ , $T_A = +25^\circ C$ , unless otherwise specified (Continued)

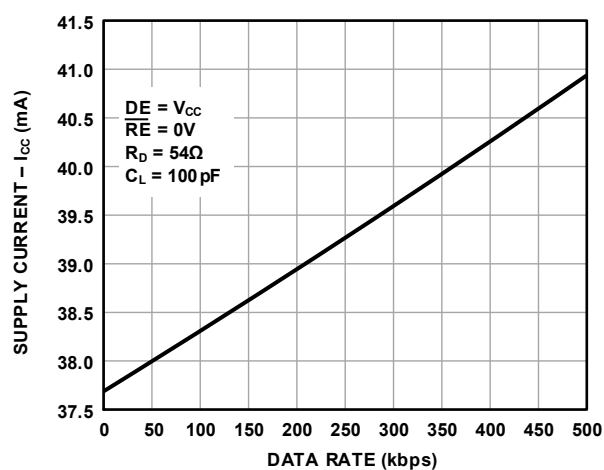


FIGURE 28. SUPPLY CURRENT vs DATA RATE (ISL3173E, ISL3175E)

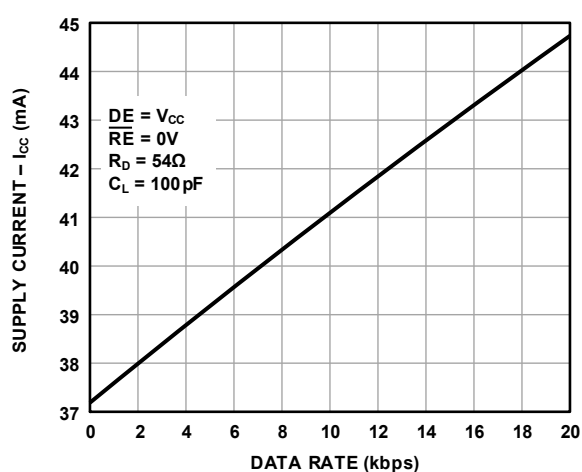


FIGURE 29. SUPPLY CURRENT vs DATA RATE (ISL3176E, ISL3178E)

## Die Characteristics

### SUBSTRATE POTENTIAL (POWERED UP):

GND

### TRANSISTOR COUNT:

535

### PROCESS:

Si Gate BiCMOS

## Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please visit our website to make sure you have the latest revision.

| REVISION | DATE         | CHANGE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|----------|--------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 6.05     | Sep 29, 2023 | Updated POD M8.15 to the latest version (corrected typo).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| 6.04     | Jul 11, 2023 | Removed High EFT information throughout.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 6.03     | Feb 16, 2023 | Added EFT features bullet.<br>Added High EFT Immunity section.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 6.02     | Jul 7, 2022  | Removed related literature section.<br>Updated links throughout.<br>Updated ordering information table format.<br>Removed Note 2.<br>Added Figures 27, 28, and 29.<br>Updated POD M8.118 to the latest version, changes are as follows:<br>-Corrected typo in the side view 1 updating package thickness tolerance from $\pm 0.10$ to $\pm 0.10$ .<br>Updated POD M8.15 to the latest version, changes are as follows:<br>-Added the coplanarity spec into the drawing.<br>Updated POD M10.118 to the latest version, changes are as follows:<br>-Corrected typo in the side view 1 updating package thickness tolerance from $\pm 0.10$ to $\pm 0.10$ .<br>Updated POD M14.15 to the latest version, changes are as follows:<br>-In Side View B and Detail A:<br>Added lead length dimension (1.27 – 0.40)<br>Changed angle of the lead to 0-8 degrees. |
| 6.01     | Nov 7, 2019  | Changed (+125mA/-100mA) to (+125 $\mu$ A/-100 $\mu$ A) in the first paragraph on page 1.<br>Removed About Intersil section.<br>Updated disclaimer                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 6.00     | Aug 31, 2017 | Applied new header/footer.<br>Added Related Literature on page 1.<br>Added Note 2 to Ordering Information table on page 2.<br>Updated the Receiving Truth table on page 4.<br>Updated POD M10.118 on page 20 from rev 0 to rev 1. Changes:<br>Updated to new POD template. Added land pattern<br>Added Revision History and About Intersil sections.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |

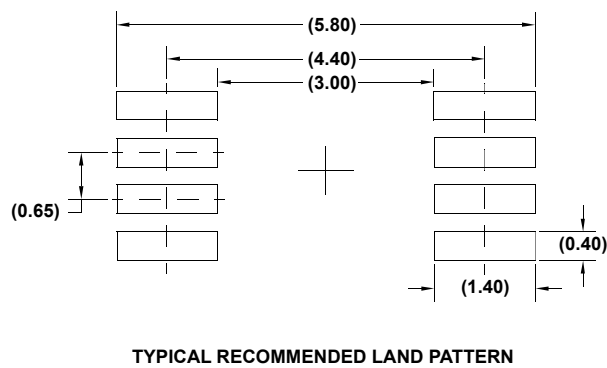
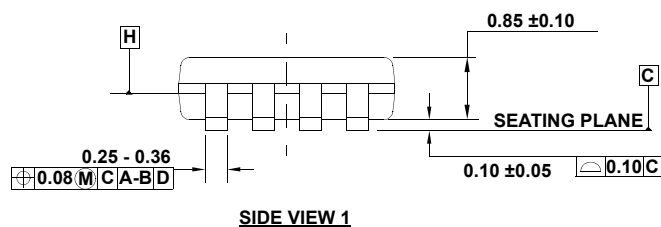
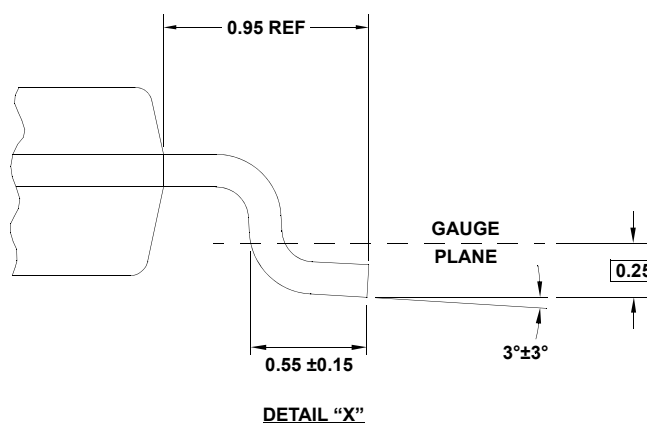
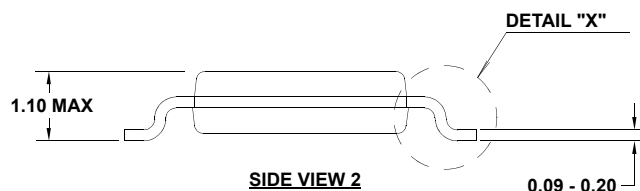
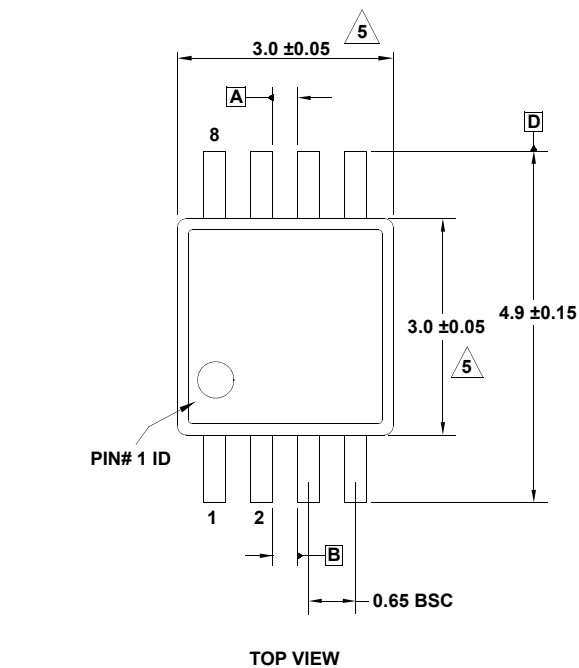
## Package Outline Drawings

For the most recent package outline drawing, see [M8.118](#).

M8.118

8 Lead Mini Small Outline Plastic Package

Rev 5, 5/2021



### NOTES:

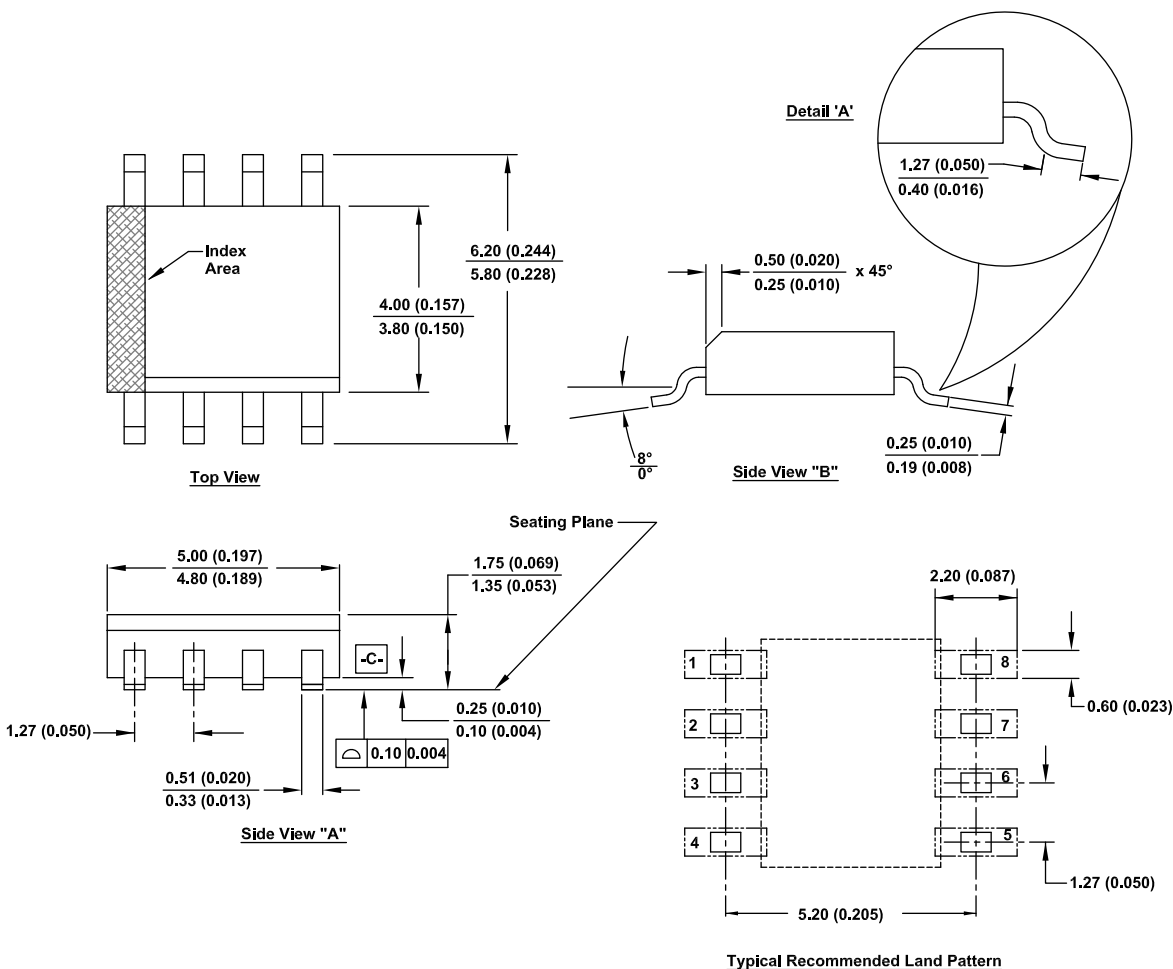
1. Dimensions are in millimeters.
2. Dimensioning and tolerancing conform to JEDEC MO-187-AA and AMSEY14.5m-1994.
3. Plastic or metal protrusions of 0.15mm max per side are not included.
4. Plastic interlead protrusions of 0.15mm max per side are not included.
5. Dimensions are measured at Datum Plane "H".
6. Dimensions in ( ) are for reference only.

For the most recent package outline drawing, see [M8.15](#).

M8.15

8 Lead Narrow Body Small Outline Plastic Package

Rev 7, 9/2023



Notes:

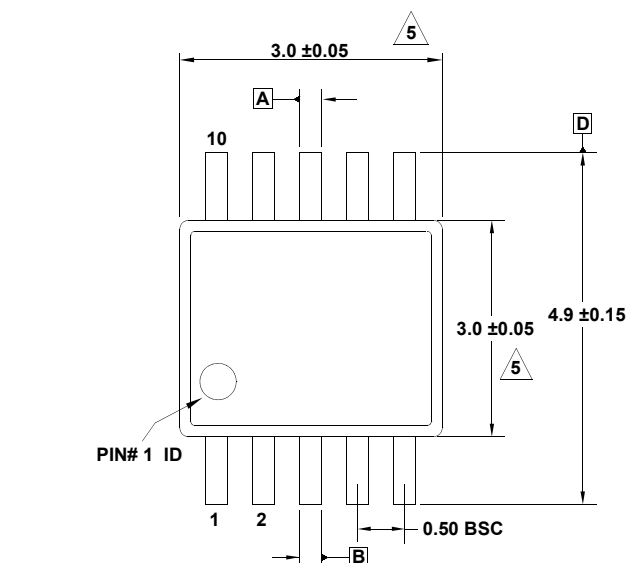
1. Dimensioning and tolerancing conform to ASME Y14.5M-1994.
2. Package length does not include mold flash, protrusion or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
3. Package width does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
4. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
5. Terminal numbers are shown for reference only.
6. The lead width as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
7. Controlling dimension: MILLIMETER. Converted inch dimension are not necessarily exact.
8. This outline conforms to JEDEC publication MS-012-AA ISSUE C.

For the most recent package outline drawing, see [M10.118](#).

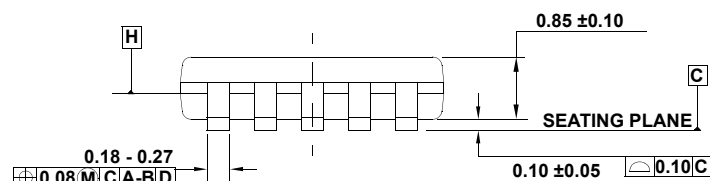
M10.118

10 Lead Mini Small Outline Plastic Package

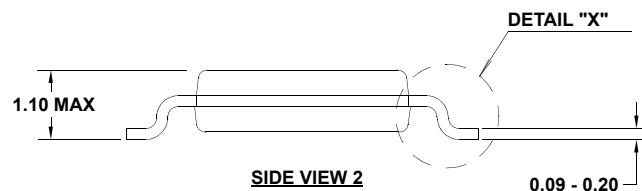
Rev 2, 5/2021



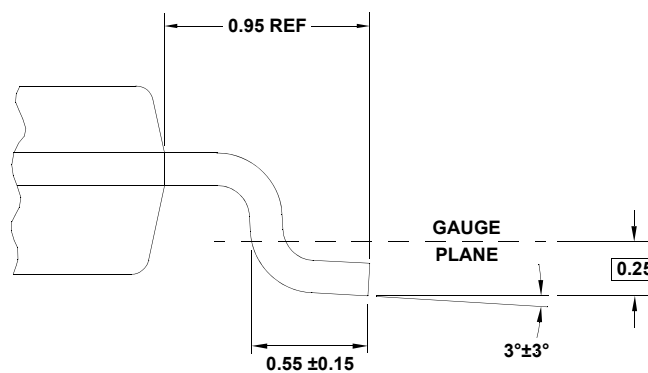
TOP VIEW



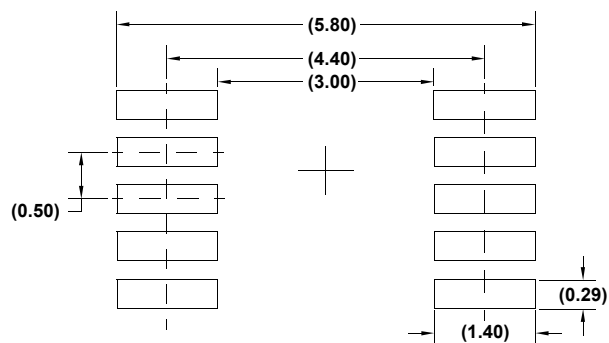
SIDE VIEW 1



SIDE VIEW 2



DETAIL "X"



TYPICAL RECOMMENDED LAND PATTERN

#### NOTES:

1. Dimensions are in millimeters.
2. Dimensioning and tolerancing conform to JEDEC MO-187-BA and AMSEY14.5m-1994.
3. Plastic or metal protrusions of 0.15mm max per side are not included.
4. Plastic interlead protrusions of 0.15mm max per side are not included.
5. Dimensions are measured at Datum Plane "H".
6. Dimensions in ( ) are for reference only.



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### Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
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